

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



In re Application of:

Serial No.: 09/944,015

Filed: August 30, 2001

For: PLASTIC LEAD FRAMES FOR
SEMICONDUCTOR DEVICES (amended)

Confirmation No.: 9929

Examiner: A. Chambliss

Group Art Unit: 2827

Attorney Docket No.: 2269-3086.7US

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

February 10, 2003
Date

Signature

Deidra Pfeil
Name (Type/Print)

LETTER TO THE CHIEF DRAFTSMAN

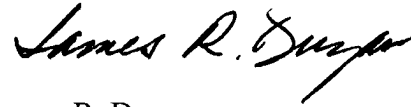
Box Issue Fee
Commissioner for Patents
Washington, D.C. 20231

Sir:

Applicant submits herewith revised FIGS. 6 and 7 which correct errors in the drawings. Specifically, FIG. 6 has been revised to delete the reference numeral "200" with appropriate lead line; and FIG. 7 has been revised to delete the reference numeral "300" with appropriate lead line. Attached is a copy of the drawings with the proposed changes marked in red.

No new matter has been added. Approval of the proposed revisions is respectfully requested.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "James R. Duzan". The signature is fluid and cursive, with a long, sweeping underline.

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Date: February 10, 2003
JRD/djp

Enclosures: Drawings with changes marked in red
Document in ProLaw

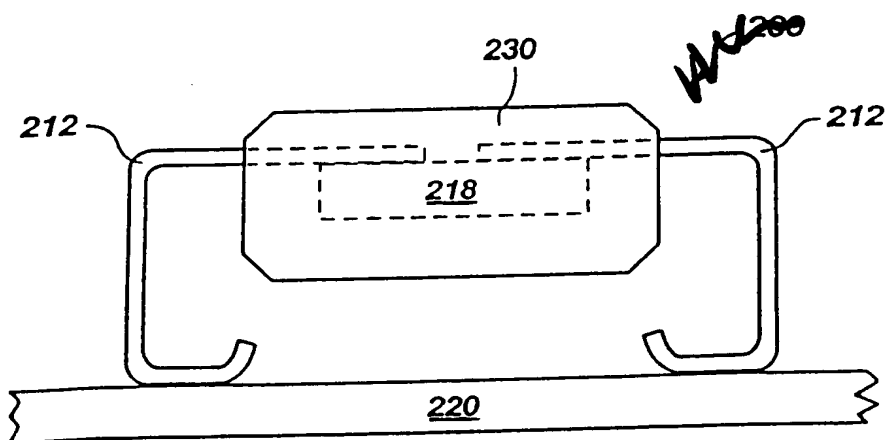


Fig. 6

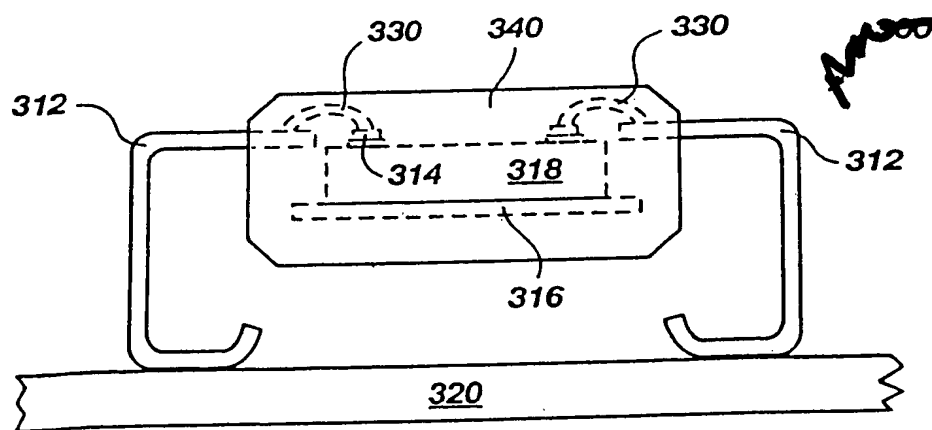


Fig. 7